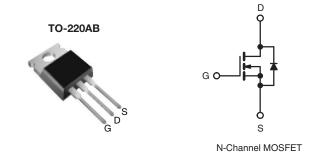


## **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	100			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V 0.16			
Q <sub>g</sub> (Max.) (nC)	26			
Q <sub>gs</sub> (nC)	5.5			
Q <sub>gd</sub> (nC)	11			
Configuration	Single			



## **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- 175 °C Operating Temperature
- · Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF530PbF		
Lead (FD)-life	SiHF530-E3		
SnPb	IRF530		
SIFD	SiHF530		

ABSOLUTE MAXIMUM RATINGS ( $T_C$	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	100	.,	
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Current	)/ -+ 10.\/	T <sub>C</sub> = 25 °C		14		
	V <sub>GS</sub> at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	I <sub>D</sub>	10	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	56		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	69	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	14	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	8.8	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	88	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature) for 10 s			-	300 <sup>d</sup>	7	
Mounting Tayous	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque			-	1.1	N⋅m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 528 \,\mu\text{H}$ ,  $R_g = 25 \,\Omega$ ,  $I_{AS} = 14 \,\text{A}$  (see fig. 12).
- c.  $I_{SD} \leq 14$  A,  $dI/dt \leq 140$  A/µs,  $V_{DD} \leq V_{DS},\, T_J \leq 175$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62			
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.7			

PARAMETER	SYMBOL	TEST (	MIN.	TYP.	MAX.	UNIT	
Static						•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	100	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I <sub>D</sub> = 1 mA		0.12	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	' <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	٧
Gate-Source Leakage	I <sub>GSS</sub>	VG	V <sub>GS</sub> = ± 20 V		-	± 100	nA
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 1	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	25	
Zero date voltage Drain ourrent	I <sub>DSS</sub>	$V_{DS} = 80 \text{ V}, \text{ V}$	$T_{GS} = 0 \text{ V}, T_{J} = 150 \text{ °C}$	ı	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 8.4 A^b$	1	-	0.16	Ω
Forward Transconductance	9 <sub>fs</sub>	$V_{DS} = 5$	$10 \text{ V}, I_D = 8.4 \text{ A}^b$	5.1	-	-	S
Dynamic							
Input Capacitance	$C_{iss}$	V	$t_{GS} = 0 \text{ V},$	ı	670	-	pF
Output Capacitance	C <sub>oss</sub>	V	<sub>DS</sub> = 25 V,	-	250	-	
Reverse Transfer Capacitance	$C_{rss}$	f = 1.0	= 1.0 MHz, see fig. 5		60	-	]
Total Gate Charge	$Q_g$			-	-	26	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 14 \text{ A}, V_{DS} = 80 \text{ V}, -10 \text{ A}$		-	5.5	nC
Gate-Drain Charge	$Q_{gd}$		see fig. 6 and 13 <sup>b</sup>	-	-	11	1
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 50 V, $I_D$ = 14 A $R_g$ = 12 $\Omega$ , $R_D$ = 3.6 $\Omega$ , see fig. 10 <sup>b</sup>		-	10	-	- ns
Rise Time	t <sub>r</sub>			-	34	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	23	-	
Fall Time	t <sub>f</sub>			-	24	-	
Internal Drain Inductance	$L_D$	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	-11
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	14	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			ı	-	56	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 14 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 14 A, dI/dt = 100 A/μs <sup>b</sup>		-	150	280	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.85	1.7	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-	on time is negligible (turn	on is do	minated b	by L <sub>S</sub> and	L <sub>D</sub> )

## Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

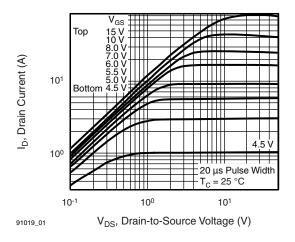


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

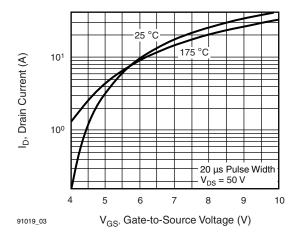


Fig. 3 - Typical Transfer Characteristics

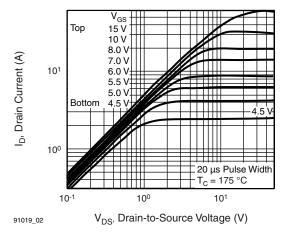


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

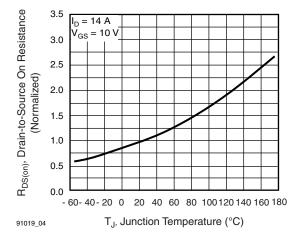


Fig. 4 - Normalized On-Resistance vs. Temperature



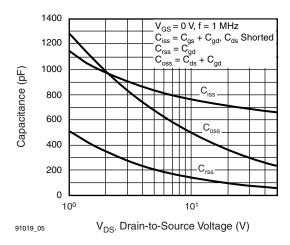


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

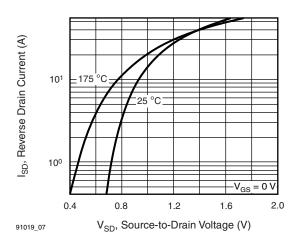


Fig. 7 - Typical Source-Drain Diode Forward Voltage

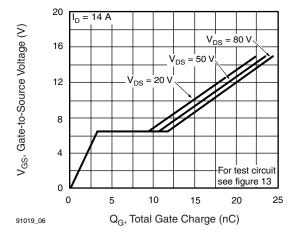


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

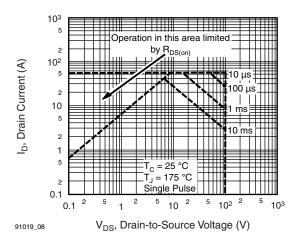


Fig. 8 - Maximum Safe Operating Area





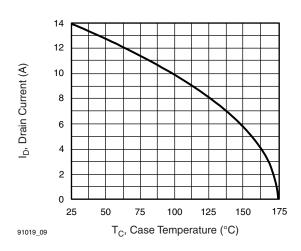


Fig. 9 - Maximum Drain Current vs. Case Temperature

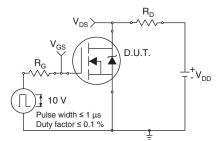


Fig. 10a - Switching Time Test Circuit

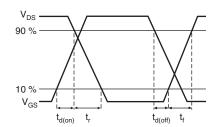


Fig. 10b - Switching Time Waveforms

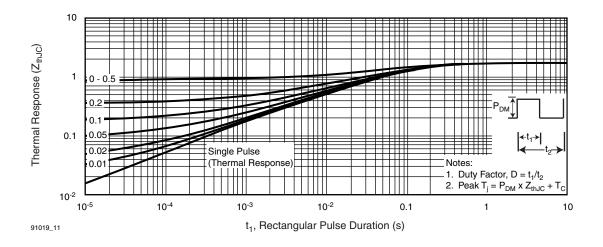


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



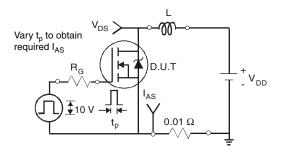


Fig. 12a - Unclamped Inductive Test Circuit

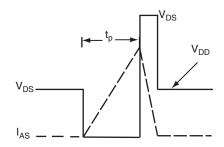


Fig. 12b - Unclamped Inductive Waveforms

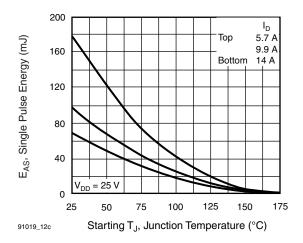


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

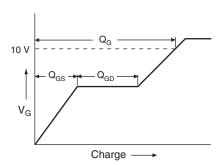


Fig. 13a - Basic Gate Charge Waveform

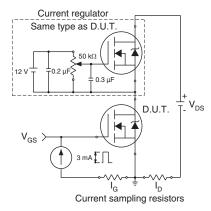
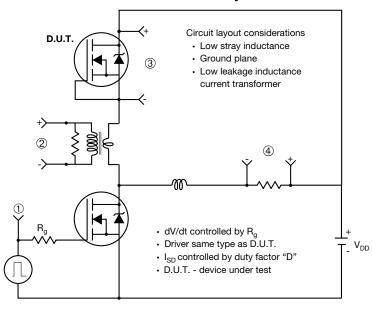


Fig. 13b - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



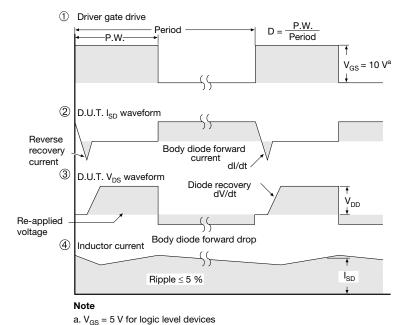


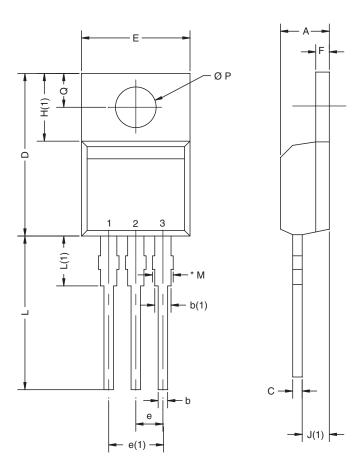
Fig. 14 - For N-Channel

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## **TO-220AB**



	MILLIMETERS		INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	4.25	4.65	0.167	0.183		
b	0.69	1.01	0.027	0.040		
b(1)	1.20	1.73	0.047	0.068		
С	0.36	0.61	0.014	0.024		
D	14.85	15.49	0.585	0.610		
Е	10.04	10.51	0.395	0.414		
е	2.41	2.67	0.095	0.105		
e(1)	4.88	5.28	0.192	0.208		
F	1.14	1.40	0.045	0.055		
H(1)	6.09	6.48	0.240	0.255		
J(1)	2.41	2.92	0.095	0.115		
L	13.35	14.02	0.526	0.552		
L(1)	3.32	3.82	0.131	0.150		
ØΡ	3.54	3.94	0.139	0.155		
Q	2.60	3.00	0.102	0.118		
ECN: X10-0416-Rev. M, 01-Nov-10						

DWG: 5471

 $<sup>^{\</sup>star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM





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